

Data sheet Product ICK S R 40 x 10



Heatsinks and active heatsinks for processors>Pin heatsinks

Ø 40 x 10 mm, pin heatsinks round

Features

design:	round
way of fixation:	• therm. conductive foil • therm. cond. adhesive
socket:	universal
suitable for processor type:	universal
diameter:	40 mm
height:	10 mm
plate thickness:	3.5 mm
weight:	15.85 g
thermal resistance:	7.1 - 1.3 K/W
dissipation loss:	8.45 W
surface:	Al-natural

Technical Drawing

